



P-CHANNEL ENHANCEMENT MODE MOSFET

Features

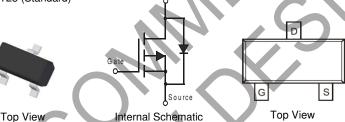
- Low On-Resistance
 - $60m\Omega @ V_{GS} = -4.5V$
 - 90mΩ @ VGS = -2.5V
 - 113mΩ @ VGS = -1.8V •
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP2305UQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/guality/product-definitions/

Mechanical Data

- Package: SOT23 .
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208(e3)
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (Approximate)

SOT23 (Standard)



Ordering Information (Note 4)

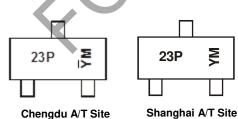
Part Number	Qualification Package		Packing			
Part Nulliber	Quanneation	Package	Qty.	Carrier		
DMP2305UQ-7	Automotive	SOT23 (Standard)	3000	Tape & Reel		

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds. 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



23P = Product Type Marking Code YM = Date Code Marking for SAT (Shanghai Assembly/ Test Site) <u>YM</u> = Date Code Marking for CAT (Chengdu Assembly/ Test Site) Y or \overline{Y} = Year (ex: J = 2022) M = Month (ex: 2 = February)

Σ

Date Code Key

Month	Jan	Feb	Mar	Apr	Mav	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Month	.lan	Feb	Mar	Δnr	May	.lun	.lul	Aua	Sep	Oct	Nov	Dec
Code	J	K	L	М	Ν	0	Р	R	S	T	U	V
Year	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characte	eristic		Symbol	Value	Unit
Drain-Source Voltage			VDSS	-20	V
Gate-Source Voltage			V _{GSS}	±8	V
Continuous Drain Current (Note 5)	Steady State	TA = +25°C TA = +70°C	lo	-4.2 -3.4	А
Pulsed Drain Current (Note 6)			Ідм	-10	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	1.4	W
Thermal Resistance, Junction to Ambient @T _A = +25°C	R _{0JA}	90	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

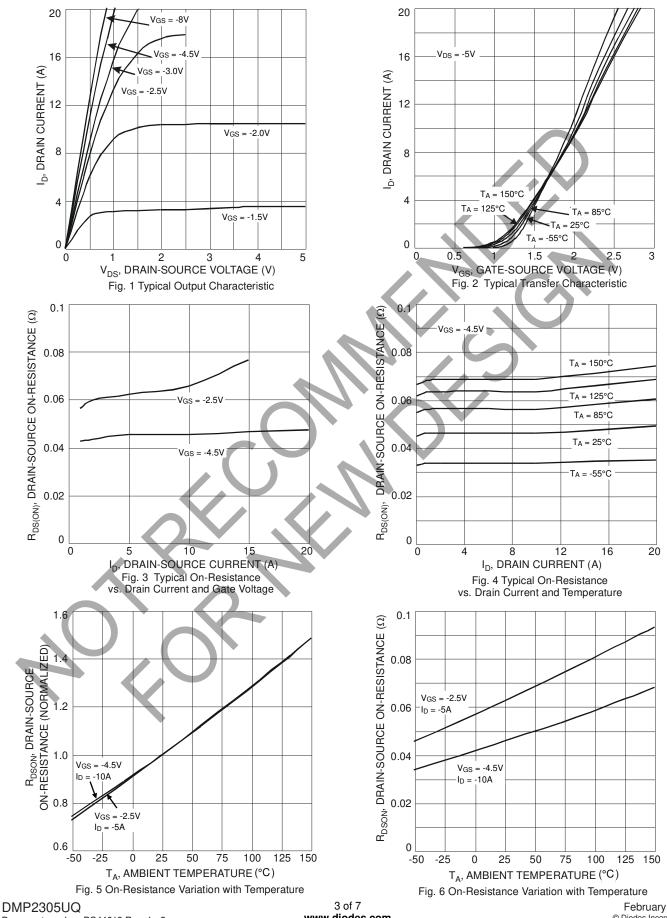
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage		-20	—		V	VGS = 0V, ID = -250µA	
Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$				-1.0	μA	$V_{DS} = -20V, V_{GS} = 0V$	
Gate-Source Leakage	lgss			±100	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	VGS(TH)	-0.5		-0.9	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	
			45	60		$V_{GS} = -4.5V, I_{D} = -4.2A$	
Static Drain-Source On-Resistance	RDS(ON)	-	60	90	mΩ	$V_{GS} = -2.5V, I_{D} = -3.4A$	
			87	113		V _{GS} = -1.8V, I _D = -2.0A	
Forward Transfer Admittance	Y _{FS}		9	_	S	$V_{DS} = -5V, I_D = -4A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		727	_	pF		
Output Capacitance	Coss		69	_	pF	V _{DS} = -20V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	64	_	pF		
Gate Resistance	Rg	· _	23	_	Ω	$V_{GS} = 0V, V_{DS} = 0V, f = 1.0MHz$	
SWITCHING CHARACTERISTICS		1	1				
Total Gate Charge	Qg		7.6	_	nC		
Gate-Source Charge	Qgs		1.4	_	nC	$V_{GS} = -4.5V, V_{DS} = -4V, I_D = -3.5A$	
Gate-Drain Charge	Qgd		1.2	_	nC		
Turn-On Delay Time	td(on)		14.0	_	ns		
Turn-On Rise Time	t _R		13.0	_	ns	$V_{DS} = -4V, V_{GS} = -4.5V,$	
Turn-Off Delay Time	td(OFF)		53.8	_	ns	$R_L = 4\Omega$, $R_G = 6\Omega$, $I_D = -1A$	
Turn-Off Fall Time	t _F		23.2		ns		

Notes:

Device mounted on FR-4 PCB with 2oz. copper and test pulse width t ≤ 10s.
Repetitive rating, pulse width limited by junction temperature.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.



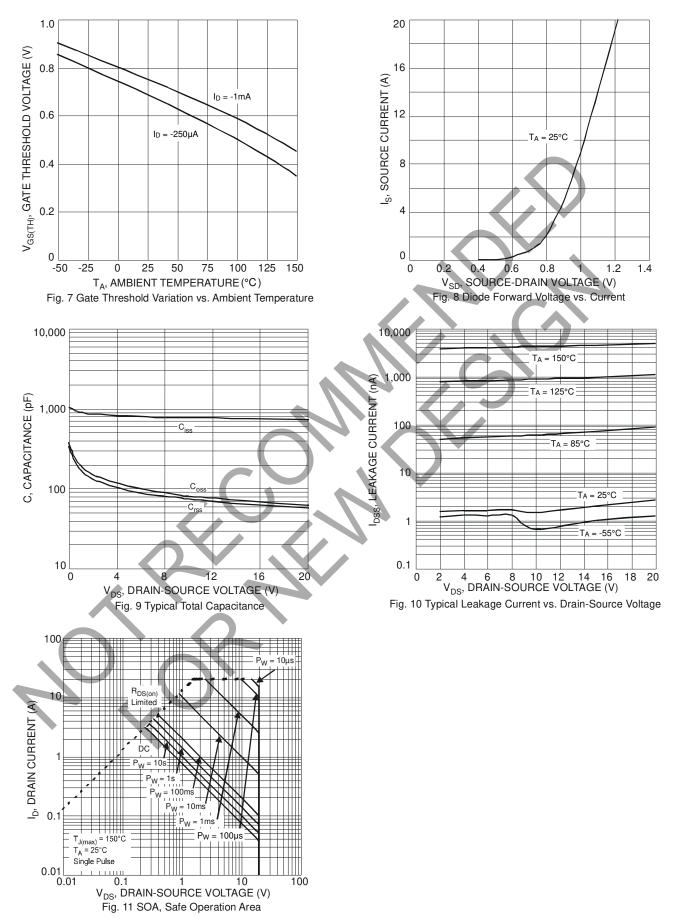


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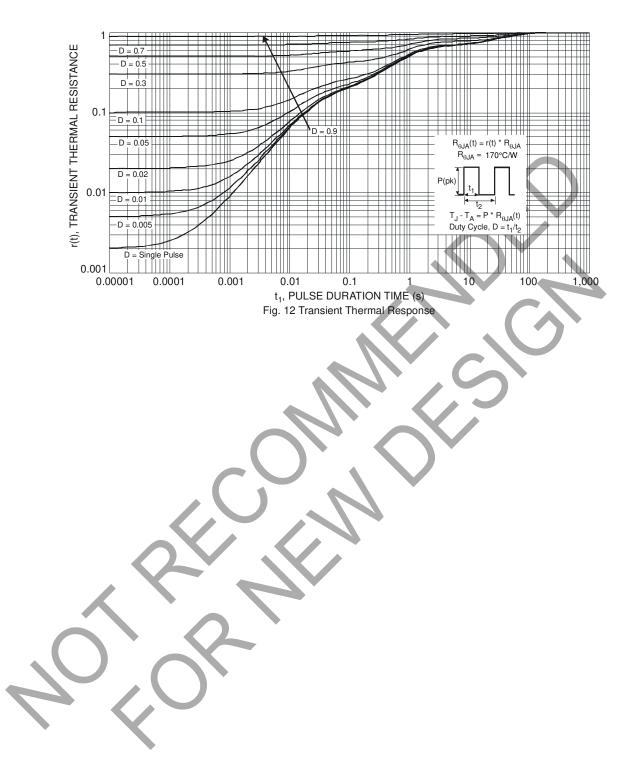
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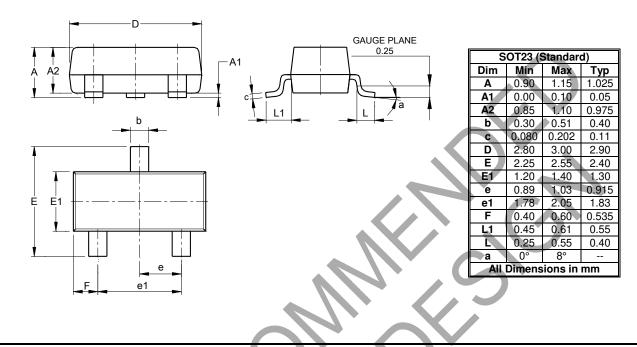






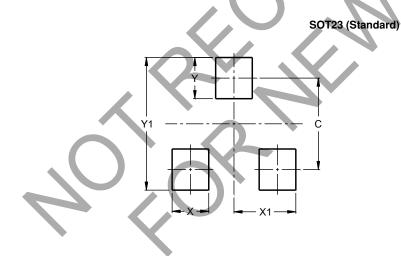
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9

SOT23 (Standard)



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